• Relevant Coursework: Differential Equations, Mechanics of Materials, Dynamics and Controls I, Toy Product Design, Design and Manufacturing 1&II, Electronics for Mechanical Systems, Cycle Ventures, Product Design & Development, Product Design, Process, Product Design, Power Electronics	
Jawbone	Sunnyvale, CA
Audio/Acoustics Product Design Intern	June'14-Aug'14
<ul> <li>Investigated molding process to prototype silicone eartips that anchor into the concha</li> <li>Explored and prototyped different form factors for an unreleased bluetooth in-ear product</li> </ul>	
<ul> <li>Strategized and CAD'ed solutions for speaker enclosure architectures while noting DFM, DF/ tolerances</li> </ul>	A, and appropriate
MIRA: HUD Navigation Helmet Attachment	Cambridge, MA
System Integrator (one of two)	Sep'13-Dec'13
• Led a team of 20 mechanical engineers in designing a Heads Up Display attachment for mot a senior capstone project	orcycle helmets for
<ul> <li>Conducted user research, created prototypes, drafted Gantt charts, product design contract</li> <li>Designed and prototyped enclosure interior mounting features and exterior shape detail</li> <li>Presented to an audience of 1500 at the end of the semester</li> </ul>	s, and slide decks
Apple	Cupertino, CA
iPad Product Design Intern	Jun'13-Aug'13
• Completed tear-down of iPad mini, documenting critical z-stack and brainstormed strategies product thinner	s to make the
<ul> <li>Created a mathematical model based on free body diagram for unreleased product in order to quantify parameters such as push force, angles, and friction</li> </ul>	
• Conducted magnetic field FEA for unreleased product and optimized magnet design to fit within leakage specs	
MIT Biomimetic Robotics Laboratory: Humanoid Cheetah	Cambridge, MA
Undergraduate Researcher	Jun'12-Aug'12
• Fixed and reassembled components of a two degree of freedom motor in CAD to further the research of achieving high torque density with minimum actuator impedance	
<ul> <li>Drafted detailed SolidWorks drawings of individual components and contracted them to be</li> <li>Progressed through multiple iterations of shoulder joint module design using FEA analysis a methods</li> </ul>	machined nd optimization

## SKILLS

- SolidWorks/ProE/NX Eagle Molding/Casting General Machine Shop Branding/Marketing Rapid Prototyping
  - Product Design Management Electronics Prototyping •

## HOBBIES

Basketball • Violin • Scuba • Guitar • DIY/hacking • Electric Vehicles •

EDUCATION

## Massachusetts Institute of Technology (MIT)

Term Address:

92 Columbia St.

Cambridge, MA 02139

• BS candidate for Mechanical Engineering with Product Design; GPA: 4.0

## **CANDACE CHEN** candacec@mit.edu

(626) 532-2520

Permanent Address: 848 North Olive Ave. Alhambra, CA 91801

Cambridge, MA

Dec'14